L Number	Hits		DB	Time stamp
1	42	(ink\$1jet or inkjet or (ink adj jet) or	USPAT;	2004/10/18 12:18
1		printhead or (liquid adj (ejecting or	US-PGPUB;	
		recording or jet))).clm. and (bonding with	EPO; JPO;	
1		temperature).clm.	DERWENT;	
_	791	((ink\$1jet or inkjet or (ink adj jet) or	IBM TDB USPAT;	2004/10/12 18:59
	, , , ,	printhead or (liquid adj (ejecting or	US-PGPUB;	2004/10/12 18:59
		recording or jet))) and method and	EPO; JPO;	
		piezoelectric).clm.	DERWENT;	
			IBM TDB	
-	12418	((ink\$1jet or inkjet or (ink adj jet) or	USPAT;	2004/10/13 18:21
:		printhead or (liquid adj (ejecting or recording or jet))) and method).clm.	US-PGPUB;	
		recording of jet/// and method).cim.	EPO; JPO; DERWENT;	
			IBM TDB	
-	22407	(ink\$1jet or inkjet or (ink adj jet) or	USPAT;	2004/10/18 09:37
		printhead or (liquid adj (ejecting or	US-PGPUB;	2001, 10, 10 03.57
		recording or jet))).clm.	EPO; JPO;	
			DERWENT;	
_	122	//imicalint an inlint and // 1 2 22 4 4	IBM_TDB	
_	123	((ink\$1jet or inkjet or (ink adj jet) or printhead or (liquid adj (ejecting or	USPAT;	2004/10/12 19:01
		recording or jet))) and method and	US-PGPUB; EPO; JPO;	
		piezoelectric and etch\$3).clm.	DERWENT;	
			IBM TDB	
_	13		USPAT;	2004/10/12 19:00
		printhead or (liquid adj (ejecting or	US-PGPUB;	
		recording or jet))) and method and	EPO; JPO;	
		piezoelectric and etch\$3 and temperature).clm.	DERWENT;	
_	92		IBM_TDB	0004/10/10 10 01
	""	printhead or (liquid adj (ejecting or	USPAT; US-PGPUB;	2004/10/12 19:01
	1	recording or jet))) and method and	EPO; JPO;	
		piezoelectric and adhesive).clm.	DERWENT;	
	007		IBM_TDB	
-	807	((ink\$1jet or inkjet or (ink adj jet) or	USPAT;	2004/10/13 18:18
		printhead or (liquid adj (ejecting or recording or jet))) and method and	US-PGPUB;	
		etch\$3).clm.	EPO; JPO; DERWENT;	
		3333737373333	IBM TDB	
-	455	(216/27).CCLS.	USPAT;	2004/10/13 18:18
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
-	197	(438/21).CCLS.	IBM_TDB	2004/10/12 12 12
		(,,,	USPAT; US-PGPUB;	2004/10/13 18:18
			EPO; JPO;	
İ			DERWENT;	
_	305	(20 (000 1) 007 0	IBM_TDB	
-	705	(29/890.1).CCLS.	USPAT;	2004/10/13 18:18
		j	US-PGPUB;	
			EPO; JPO; DERWENT;	
		•	IBM TDB	
-	422	(((216/27).CCLS.) or ((438/21).CCLS.) or	USPAT;	2004/10/13 18:22
		((29/890.1).CCLS.)) and (method and	US-PGPUB;	,
Ì		etch\$3).clm.	EPO; JPO;	
	1		DERWENT;	
_	43	(((216/27).CCLS.) or ((438/21).CCLS.) or	IBM_TDB USPAT;	2004/20/12 10 00
ļ		((29/890.1).CCLS.)) and (method and etch\$3	US-PGPUB;	2004/10/13 18:20
i	İ	and piezoelectric).clm.	EPO; JPO;	
			DERWENT;	
	55.6	(247/22)	IBM_TDB	
-	776	(347/20).CCLS.	USPĀT;	2004/10/13 18:19
			US-PGPUB;	
			EPO; JPO;	
			DERWENT; IBM TDB	
			T-014 1 DD	·

	T 021	(247/40) 0010	I tIODAM.	1 2004 /10 /13 10-10
-	831	(347/40).CCLS.	USPAT;	2004/10/13 18:19
			US-PGPUB;	
1			EPO; JPO;	
			DERWENT;	
	500	(247/44) 0070	IBM_TDB	0004/10/10 10 10
-	520	(347/44).CCLS.	USPAT;	2004/10/13 18:19
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	1347	(347/47).CCLS.	USPAT;	2004/10/13 18:19
	l		US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
-	805	(347/54).CCLS.	USPAT;	2004/10/13 18:19
			US-PGPUB;	
	}		EPO; JPO;	
			DERWENT;	
			IBM TDB	
-	525	(347/63).CCLS.	USPAT;	2004/10/13 18:20
			US-PGPUB;	
			EPO; JPO;	
	-		DERWENT;	
	1		IBM TDB	
_	1636	(347/68).CCLS.	USPAT;	2004/10/13 18:20
	1000	(311,00,:0015.	US-PGPUB;	2004/10/13 18.20
			EPO; JPO;	
			DERWENT;	
		, , , , , , , , , , , , , , , , , , ,		
_	165	(347/69).CCLS.	IBM_TDB USPAT;	2004/10/13 18:20
	100	(347769).CCL3.		2004/10/13 18:20
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
	537	(247/70) GOT 0	IBM_TDB	0000440040
	537	(347/70).CCLS.	USPAT;	2004/10/13 18:20
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	575	(347/71).CCLS.	USPAT;	2004/10/13 18:20
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	ļ i
-	192	(347/72).CCLS.	USPAT;	2004/10/13 18:20
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	105	(((347/20).CCLS.) or ((347/40).CCLS.) or	USPĀT;	2004/10/13 18:22
		((347/44).CCLS.) or ((347/47).CCLS.) or	US-PGPUB;	
		((347/54).CCLS.) or ((347/63).CCLS.) or	EPO; JPO;	
		((347/68).CCLS.) or ((347/69).CCLS.) or	DERWENT;	
		((347/70).CCLS.) or ((347/71).CCLS.) or	IBM TDB	•
		((347/72).CCLS.)) and (method and etch\$3		
	l	and piezoelectric).clm.		
-	487	(((347/20).CCLS.) or ((347/40).CCLS.) or	USPAT;	2004/10/13 18:24
		((347/44).CCLS.) or ((347/47).CCLS.) or	US-PGPUB;	,,
		((347/54).CCLS.) or ((347/63).CCLS.) or	EPO; JPO;	ļ
	İ	((347/68).CCLS.) or ((347/69).CCLS.) or	DERWENT;	
	ļ	((347/70).CCLS.) or ((347/71).CCLS.) or	IBM TDB	
		((347/72).CCLS.)) and (method and		
		piezoelectric).clm.		

-	410	((((347/20).CCLS.) or ((347/40).CCLS.) or	USPAT;	2004/10/13 18:24
		((347/44).CCLS.) or ((347/47).CCLS.) or	US-PGPUB;	ť
ļ		((347/54).CCLS.) or ((347/63).CCLS.) or	EPO; JPO;	
		((347/68).CCLS.) or ((347/69).CCLS.) or	DERWENT;	
		((347/70).CCLS.) or ((347/71).CCLS.) or	IBM TDB	
		((347/72).CCLS.)) and (method and		
		piezoelectric).clm.) not	*	· .
		((((216/27).CCLS.) or ((438/21).CCLS.) or		
		((29/890.1).CCLS.)) and (method and		
		piezoelectric).clm.)		
-	132		USPAT;	2004/10/13 18:23
		((29/890.1).CCLS.)) and (method and	US-PGPUB;	
		piezoelectric).clm.	EPO; JPO;	
		'	DERWENT;	
	į		IBM TDB	
	81	(((216/27).CCLS.) or ((438/21).CCLS.) or	USPAT;	2004/10/18 09:34
	, , ,	((29/890.1).CCLS.)) and (method and	US-PGPUB;	2004/10/10 09.54
		piezoelectric).clm. and etch\$3	EPO; JPO;	
İ		proboticotic, cim. and econys	DERWENT;	
			•	
l _	258	(((347/20).CCLS.) or ((347/40).CCLS.) or	IBM_TDB	2004/10/13 13 3:
_	230		USPAT;	2004/10/13 18:24
		((347/44).CCLS.) or ((347/47).CCLS.) or	US-PGPUB;	
		((347/54).CCLS.) or ((347/63).CCLS.) or	EPO; JPO;	
		((347/68).CCLS.) or ((347/69).CCLS.) or	DERWENT;	1
		((347/70).CCLS.) or ((347/71).CCLS.) or	IBM_TDB	ļ
		((347/72).CCLS.)) and (method and		
	1	piezoelectric).clm. and etch\$3		
-	215	((((347/20).CCLS.) or ((347/40).CCLS.) or	USPAT;	2004/10/13 18:24
		((347/44).CCLS.) or ((347/47).CCLS.) or	US-PGPUB;	
		((347/54).CCLS.) or ((347/63).CCLS.) or	EPO; JPO;	
		((347/68).CCLS.) or ((347/69).CCLS.) or	DERWENT;	
		((347/70).CCLS.) or ((347/71).CCLS.) or	IBM TDB	
		((347/72).CCLS.)) and (method and	_	
		piezoelectric).clm. and etch\$3) not		
		((((216/27).CCLS.) or ((438/21).CCLS.) or		
		((29/890.1).CCLS.)) and (method and		
		piezoelectric).clm. and etch\$3)		
-	1	(((216/27).CCLS.) or ((438/21).CCLS.) or	USPAT;	2004/10/18 09:35
	_	((29/890.1).CCLS.)) and (method and	US-PGPUB;	=====================================
		piezoelectric and (thermal\$3 adj (bond\$3	EPO; JPO;	
		or adher\$3))).clm.	DERWENT;	
		or admorto///.crm.	_	
_	3	(((216/27).CCLS.) or ((438/21).CCLS.) or	IBM_TDB	2004/10/10 00 36
		((29/890.1).CCLS.)) and (thermal\$3 adj	USPAT;	2004/10/18 09:36
			US-PGPUB;	
		(bond\$3 or adher\$3)).clm.	EPO; JPO;	
			DERWENT;	
_	10	/i-161i-4 i-1i-1i-1 // 2 - 2 - 1 - 2	IBM_TDB	
-	13	(ink\$1jet or inkjet or (ink adj jet) or	USPAT;	2004/10/18 12:18
		printhead or (liquid adj (ejecting or	US-PGPUB;	ŀ
		recording or jet))).clm. and (thermal\$3	EPO; JPO;	
		adj (adher\$3 or bond\$3)).clm.	DERWENT;	
			IBM_TDB	